



TB-02 Specification

Version V1.0

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Document development/revision/revocation resume



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1.INTRODUCTION

The TB-02 intelligent lighting module is a Bluetooth module based on the TLSR8250F512 chip and compatible with BT 5.0 low-power Tmall Genie Mesh. This module supports the Bluetooth module directly controlled by Tmall Genie and has a Bluetooth mesh networking function. Peer-to-peer network communication, using Bluetooth broadcast for communication, can ensure timely response in the case of multiple devices. It is mainly used in intelligent light control, which can meet the requirements of low power consumption, low latency, and short-range wireless data communication.

Features

- Can be directly controlled by Tmall Elf without a gateway
- 1.6mm pitch pin vertical solder DIP18 or SMD-13 package
- 6 PWM outputs
- With on-board antenna, no need to design antenna
- Brightness (duty cycle) adjustment range 5% -100%
- Factory default 50% duty cycle for cool and warm colors
- PWM output power 1KHz
- With night light function
- With wall switch to switch color temperature function



Model Name	ТВ-02		
Size	18.0*18.0*2.8(±0.2)MM		
Package	DIP-18 or SMD-13		
Wireless Standard	Bluetooth V5.0		
Frequency Range	2400 ~ 2483.5MHz		
Output Power 10dBm			
Sensitivity	-93dBm		
Interface	GPIO/PWM/SPI/ADC		
Work Temperature	-40℃ ~ 85 ℃		
Store Temperature	-40 ℃ ~ 125 ℃ <i>,</i> < 90%RH		
Voltage Range	Voltage 2.7V ~ 3.6V, Current≥50mA		
	Deep Sleep Mode: 0.8uA		
Power	Sleep Mode: 1.8uA		
	TX: 12.62mA		
Transmission distance80m ~ 150m			

LIST 1 Main Parameters



2.SPECIFICATION

Electrical characteristics

Absolute Maximum Rating

Any exceeding the following absolute maximum ratings may cause damage to TLSR8250F512

Item	Min	Typical	Max	Unit
Voltage	2.7	3.3	3.6	V
I/O Voltage (VCCIO)	-0.3	-	3.6	V
Work Temperature	-40	-	+85	°C
Store Temperature	-40	-	+125	°C

RF Specification

Output Power

Item	Min	Typical	Max	Unit
Average Power	7.1dBm	8.5dBm	10dBm	dBm

Sensitivity

Item	Min	Typical	Max	Unit
Sensitivity	-93.2dBm	-93dBm	-92dBm	dBm



3.DIMENSION









4.PIN DEFINITION

The TB-02 module has a total of 22 interfaces. For example, the pin diagram, the pin function definition table is the interface definition.



TB-02 Pin diagram

PIN function definition sheet

No.	ltem	Function Description	
1	GND	Ground	
2	3V3	Electricity supply	
3	ТХО	PWM4 output/UART_TX/SAR ADC input/GPIO PB1	
4	RXO	PWM0 inverting output/UART_RX/GPIO PA0	
5	SWS	Single wire slave/UART_RTS/GPIO PA7	
6	A1	GPIO PA1	
7	D7	GPIO PD7/SPI clock (I2C_SCK)	
8	D4	GPIO PD4/Single wire master/PWM2 inverting output	
9	D3	PWM1 inverting output/GPIO PD3	
10	D2	SPI chip select (active low) /PWM3 output/GPIO PD2	
11	C4	PWM2 output/UART_CTS/PWM0 inverting output /SAR ADC input/GPIO PC4	
12	С3	PWM1 output/UART_RX/I2C serial clock/32kHz crystal input (optional) /GPIO PC3	
13	C2	PWM0 output/I2C serial data/32kHz crystal output(optional) /GPIO PC2	



14	B4	PWM4 output/SAR ADC input/GPIO PB4
15	B5	PWM5 output/SAR ADC input/GPIO PB5
16	B6	SPI data input (I2C_SDA) /UART_RTS/SAR ADC input/GPIO PB6
17	Β7	SPI data output/UART_RX/SAR ADC input/GPIO PB7
18	RST	RESET
19	3V3	Electricity supply
20	ТХ	UART_TX
21	GND	Ground
22	SWS	Single wire slave



5.SCHEMATIC



6.DESIGN GUIDE

1. Application circuit





2、 Recommended module package design size

Note: Below is the TB-02 module package diagram, it is recommended to design the PCB board according to this diagram, so that the module can work normally on the PCB board; and pay attention to the design of the pad, the design of the pads on the PCB can not be offset from the corresponding pads of the module, and the expansion of the PCB pads relative to the module pads does not affect the use of the module.



3、Antenna layout requirements

Place the module on the edge of the motherboard, and the antenna area extends beyond the edge of the motherboard.

4、Electricity Supply

(1) Recommended 3.3V voltage, peak current above 50mA

(2) It is recommended to use LDO power supply; if using DC-DC, it is recommended to control the ripple within 30mV.

(3) The DC-DC power supply circuit is recommended to reserve the position of the dynamic response capacitor, which can optimize the output ripple when the load changes greatly.

(4) 3.3V power interface is recommended to add ESD devices.



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5、PWM Dimming Solution Design Instructions

For lamps that require dimming, you only need to connect the PWM pins of the corresponding color to the control end of the subsequent stage drive circuit; the PWM independently outputs a 100-level adjustable digital signal, and the subsequent stage circuit can be voltage The driving type may be a current driving type. Connection diagram



6、 LED Drive Reference Design

TB-02 module application only needs 3.3V power supply and simple driving circuit to achieve intelligent light control. Take MOS tube to drive a channel of white light as an example, the design reference is as follows; CW_I is the module's positive white light PWM output, Q1 is MOS tube, WW is LED lamp beads, the other 4 road lamp driving circuit is the same as this road design method.



7、Secondary development

The TB-02 module supports users to write their own firmware programs to achieve customized functions. If you use a Linux machine to develop the firmware, you can refer to the SDK, documentation and source address of Anxin's collation:

https://github.com/Ai-Thinker-Open/Telink 825X SDK.

If you use Windows development, you can refer to the original SDK provided by the chip manufacturer. Download address:

http://wiki.telink-semi.cn.



7.REFLOW PROFILE







8.PACKAGING

As shown below, the packaging of TB-02 is taping packaging.



9.CONTACT US

- Company Website: <u>https://www.ai-thinker.com</u>
- Development DOCS: <u>https://docs.ai-thinker.com</u>
- Official Forum: <u>http://bbs.ai-thinker.com</u>
- Sample Purchase: <u>https://anxinke.taobao.com</u>
- Business: sales@aithinker.com
- Technical Support: support@aithinker.com



Shenzhen

Tel: 0755-29162996



